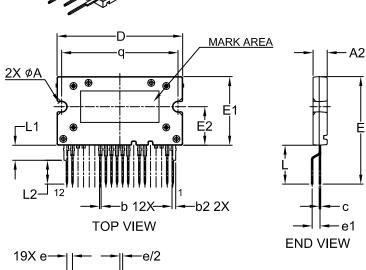
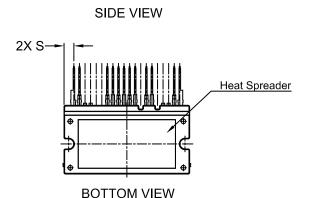


APMCD-A16 / 12LD, AUTOMOTIVE MODULE

CASE MODGG ISSUE C

DATE 03 NOV 2021





NOTES:

- 1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
A2	4.30	4.50	4.70	
b	0.45	0.50	0.60	
b2	1.15	1.20	1.30	
С	0.45	0.50	0.60	
D	39.90	40.10	40.30	
Е	33.80	34.30	34.80	
E1	21.70	21.90	22.10	
E2	12.10	12.30	12.50	
е	1.478	1.778	2.078	
e1	2.20	2.50	2.80	
L	12.10	12.40	12.70	
L1	4.80 REF			
L2	7.30	7.60	7.90	
q	36.85	37.10	37.35	
S	3.159 REF			
ØΑ	3.00	3.20	3.40	

GENERIC MARKING DIAGRAM*

XXXXXXXXXXXXXXXX ZZZ ATYWW NNNNNNN XXXX = Specific Device Code

ZZZ = Lot ID

AT = Assembly & Test Location

Y = Year WW = Work

WW = Work Week
NNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION: APMCD-A16 / 12LD. AUTOMOTIVE MODULE		DMOTIVE MODULE	PAGE 1 OF 1

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